

One-stop storage device supply solution



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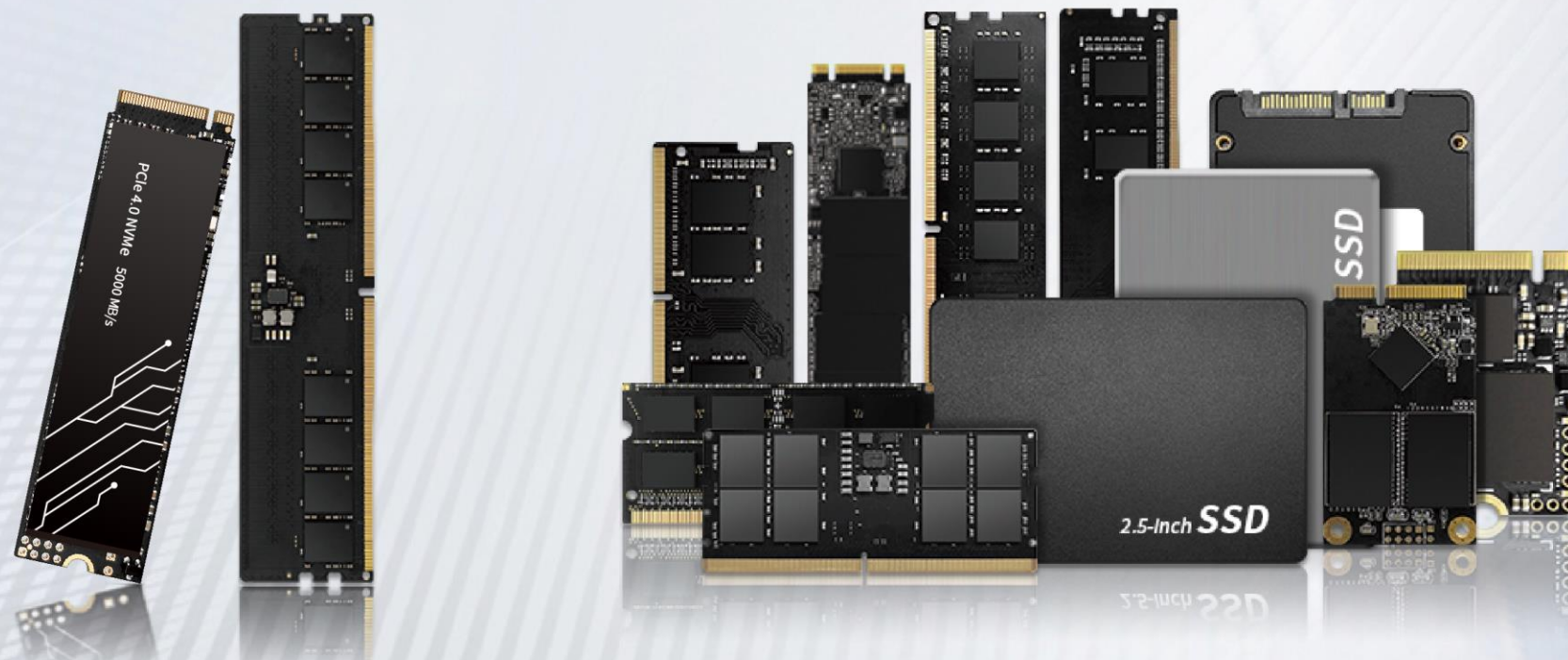
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Chuangshi Feida provides you with

ONE STOP STORAGE SUPPLY SOLUTION

Adhere to quality
Technical support
Service hotline
Professional services



CONTENT

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· 2.5"SATA SSD	· M.2 NGFF SSD
· mSATA SSD	· NVMe 3.0/NVMe 4.0
· DDR5/DDR4/DDR3UDIMM RAM	
· DDR5/DDR4/DDR3 SODIMM RAM	
· Portable SSD/U DISK	· RGB RAM



COMPANY INTRODUCTION



Shenzhen Chuangshi Feida Technology Co., Ltd

Located in Shenzhen, the city with the highest spirit of scientific and technological innovation in China, is a high-tech enterprise with design, research and development, production and sales in the domestic semiconductor storage field. We have been deeply involved in the semiconductor storage industry for more than 10 years, and has fully entered the research and development and production of SSD products. So far, it has cooperated with well-known manufacturer and other related enterprises and institutions, and has achieved a nice reputation.

We always put quality in the most important position through strictly quality control procedure. and all products have passed FCC, CE, ROHS etc international certification authorities. It has adhered to the technology-driven independent innovation route and has achieved many technical patents such as SSD etc, DRAM memory and has many business range such as OEM, ODM & chip trade. business groups such as OEM, ODM, chip trading, and product brands.



it has strong production capacity, more than 100 employees, and a factory area of nearly 5,000 square meters. The factory has passed ISO9001, ISO14000 quality system certification, and more than 200 product models fully cover various storage product series to meet the different needs of global users. Taiwan Semiconductor Storage Advanced production testing in the industry combined with independent innovative production process to ensure pipeline products: the product concept of high quality, batch, consistency and excellence guarantees high product quality.

We have an excellent management team, and is equipped with professionals from product selection, design, research and development, evaluation, production, quality inspection and others, so as to ensure that customers are 100% satisfied and assured of their products.

发展历程

2013

Shenzhen Chuangshi Feida Technology Co., Ltd was established. Mainly engaged in chip sales in the domestic market.

2016

Integrate upstream high-quality resources. Established industry application field plan construction.

Chuangshi Feida Factory successfully passed ISO9001 certification. The company introduces Type-C USB 3.1 Gen2 SSD.

2015

Establish production lines, R&D and testing to create a supply chain ecosystem.

2017

Expand production scale by 3,000 square meters. Access to Industry Storage Association.

2019

Fully enter the international market. Chuangshi Feida products go global. Strategic partnership with INNOGRIT, REALTEK, SMI, YMTC, INTEL, Hynix.

2020

Expand the scale of the enterprise.

2023

high-tech invention. Multiple invention patents.

2024...

We continue to move forward...

**More than 11 years
experiences,
diverse authorized
patents**

ENTERPRISE PROJECT



- Shenzhen Chuangshi Feida Technology Co., Ltd. operates ODM 、 OEM 、 SSD solid-state drive DRAM memory, PSSD solid-state drive, U disk, memory card and other storage products, domestic trade OEM, international trade OEM. Adhering to the business philosophy of professionalism, efficiency, innovation and service and cutting-edge technical team, laboratory and manufacturing equipment, with strong vertical integration capabilities of product design, raw material acquisition, production process and quality inspection, with the help of upstream chips and DRAM resources, leading the industry to launch the latest memory modules.
- Mastering the upstream chips and DRAM resources, and working closely with YMTC, combined with own precision equipment processing factory and ISO production standard system, it ensures the excellent quality and performance of product production.

OEM. ODM PRODUCT LINE



01

OEM SERVICES

02

PROFESSIONAL
QUALITY CONTROL
MANAGEMENT

03

APPLICATION
PRODUCT LINES

Fast and efficient service system

Shenzhen Chuangshi Feida Technology Co, Ltd. masters NAND and DRAM resources, and has close cooperation with Samsung, Hynix Micron and other chip manufacturers, combined with the company's own precision equipment processing factory and ISO production standard system, to ensure product production. Excellent quality and performance.

战略合作伙伴

INNOGRIT
英 韧 科 技

REALTEK
瑞昱半導體股份有限公司

SiliconMotion

YEESTOR

UMC
聯華電子

长江存储
YANGTZE MEMORY

intel

Micron

SK hynix

SAMSUNG

Strategic partner

- Own Factory Production
Quality with after-services Guarantee
- Closely work with SSD master technology
SSD master control technology guarantee
- Cooperated with massive OEM factory
SSD supply is stable
- Closely cooperated with original DRAM/SSD Chips factories
RAM/SSD Resources Guarantee

M.2 NVMe 3.0 solid state drive



OEM/ODM customized service:

Provide customization: packagemodel,
shell, label, BOM

Application



边缘计算



ITD



ITD



IPC



MEC

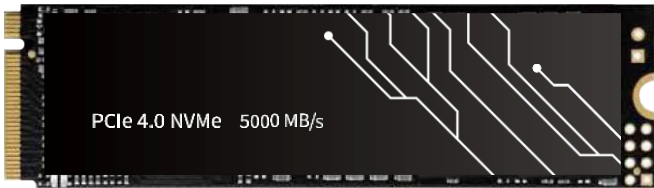
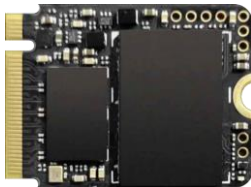


PPC

Product Specifications

Product model	C650 2280						C650 2242				C650 2230			
Overall dimension	80mm*22mm*3.5mm						42mm*22mm*3.5mm				30mmx22mmx3.5mm			
Interface type	M.2 NVMe													
Transmission speed	PCIe GEN3.0X4													
Capacity	128GB	256GB	512GB	1TB	2TB	4TB	128GB	256GB	512GB	1TB	256GB	512GB	1TB	
NAND	3D NAND FLASH													
Continuous reading speed MB/s	≥1000	≥1500	2300-3400	2500-3500	2500-3500	3500	≥1000	≥1500	≥1800	2500-3500	≥1500	2300-3400	2500-3500	
Continugus write speed MB/s	≥550	≥1000	1800-2800	2000-3000	1800-3000	2500	≥550	≥1000	≥1200	2000-3000	≥1000	1800-2800	2000-3000	
Working voltage	DC3.3±5%													
Working power consumption	2.5W													
Data saving	It can be stored for more than 10 years at 25℃													
Error checking and correction	LDPC													
Working temperature	0~70°													
Earthquake resistance	80Hz~2000Hz/20G													
Shockproof ability	1500G/0.5MS													
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG													
Characteristic	Support LDPC error correction engine / Support HMB function / Support NVMe 1.3 protocol Supports multiple power modes (PS0, PS1, PS2, PS3, PS4) / Dynamic wear balance function													

M.2 NVMe 4.0 5000MB/s SSD



M.2 NVMe 4.0 5000MB/S SSD

Non-Volatile Memory Express, a non-volatile memory standard is a standard protocol that runs on the PCIe interface, which is a protocol for communication between the host and the SSD.

OEM/ODM customized service

Provide customization: package,model, shell, label, BOM

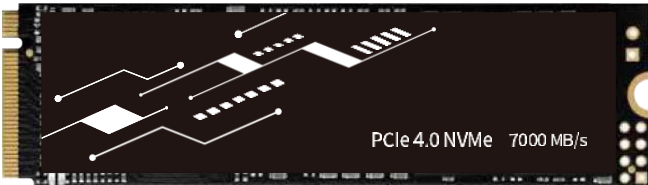
Application



Product Specifications

Product model	C750 2280				C750 2230	
Overall dimension	80mm*22mm*3.5mm				30mm*22mm*3.5mm	
Interface type	M.2 NVMe					
Transmission speed	PCIe GEN4.0X4					
Capacity	512GB	1TB	2TB	4TB	512GB	1TB
NAND	3D NAND FLASH					
Continuous reading speed MB/s	4900	5000	4800	5000	5000	5000
Continugus write speed MB/s	2700	4500	4300	4500	2700	4500
Working voltage	DC3.3±5%					
Working power consumption	2.5W Max					
Data saving	It can be stored for more than 10 years at 25°C					
Error checking and correction	LDPC					
Working temperature	0~70°					
Earthquake resistance	80Hz~2000Hz/20G					
Shockproof ability	1500G/0.5MS					
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG					
Characteristic	Support LDPC error correction engine / Support ATA-8 standard Support SATA I/II/III interface / Support hot swap Support power management / Support S.M.A.R.T function Dynamic wear balance function / Support TCG· OPAL2.0					

M.2 NVMe 4.0 7000MB/s SSD



M.2 NVMe 4.0 7000MB/s SSD

Non-Volatile Memory Express, a non-volatile memory standard is a standard protocol that runs on the PCIE interface, which is a protocol for communication between the host and the SSD.

OEM/ODM customized

Provide customization: package,model, shell, label, BOM

Application



Product Specifications

Product model	C770 2280			
Overall dimension	80mm*22mm*3.5mm			
Interface type	M.2 NVMe			
Transmission speed	PCIE GEN4.0X4			
Capacity	512GB	1TB	2TB	4TB
NAND	3D NAND FLASH			
Continuous reading speed MB/s	7100	7300	7100	7100
Continugus write speed MB/s	2700	5500	6500	6500
Working voltage	DC3.3±5%			
Working power consumption	3W Max			
Data saving	It can be stored for more than 10 years at 25°C			
Error checking and correction	LDPC			
Working temperature	0~70°			
Earthquake resistance	80Hz~2000Hz/20G			
Shockproof ability	1500G/0.5MS			
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG			
Characteristic	Support LDPC error correction engine / Support ATA-8 standard Support SATA I/II/III interface / Support hot swap Support power management / Support S.M.A.R.T function Dynamic wear balance function / Support TCG- OPAL2.0			

2.5" SATA SSD



2.5" SATA SSD

The storage medium used in solid-state hard drives is flash memory, which has the advantages of fast startup, fast reading time, no need for address-mo, and can cdirectly read data.The storae medium of sold-state hard drives is fash memory particies. without mechanica parts. So it has stronoshock resistance.

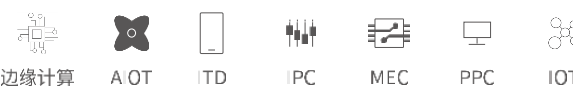
Product Specifications

Product model	C500							
Overall dimension	100mm*70mm*7.0mm							
Interface type	2.5" SATA							
Transmission speed	SATAIII 6Gbps							
Capacity	120-240GB	480GB	960GB	128GB-256GB	512GB	1TB	2TB	4TB
NAND	3DTLC/QLC							
Continuous reading speed MB/s	≥450	≥500	≥520	450-500	≥500	≥520	500-550	550
Continugus write speed MB/s	≥400	≥450	≥500	400-450	≥450	≥500	500-520	520
Working voltage	DC 5V±5%							
Working power consum	2.5W							
Data saving	It can be stored for more than 10 years at 25°C							
Error checking and correction	LDPC							
Working temperature	0~70°							
Earthquake resistance	80Hz~2000Hz/20G							
Shockproof ability	1500G/0.5MS							
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG							
Characteristic	Support LDPC error correction engine / Support ATA-8 standard Support SATA I/II/III interface / Support hot swap Support power management / Support S.M.A.R.T function Dynamic wear balance function / Support TCG· OPAL2.0							

OEM/ODMcustomized service

Provide customization: package, model, shell, label, BOM

Application





OEM/ODM customized service

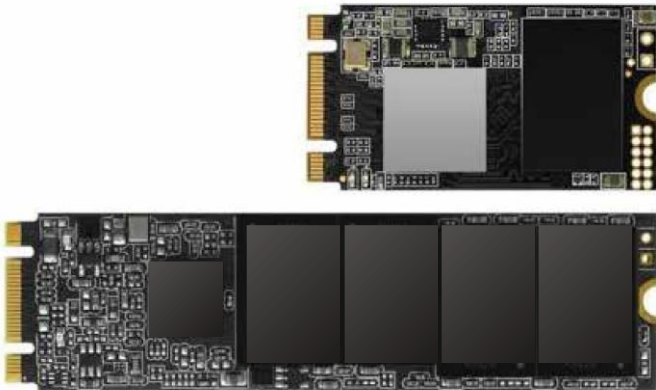
Application



PPC

Product model	C550						
Overall dimension	51mm*30mm*3.5mm						
Interface type	mSATA						
Transmission speed	SATAIII 6Gbps						
Capacity	32GB	64GB	128GB	256GB	512GB	1TB	2TB
NAND	3D TLC / QLC						
Continuous reading speed MB/s	≥250	≥350	≥450	450-500	450-500	500-550	500-550
Continugus write speed MB/s	≥150	≥300	≥400	400-450	400-450	480-500	500-520
Working voltage	DC 5V±5%						
Working power consum	2.35-2.65W						
Data saving	It can be stored for more than 10 years at 25°C						
Error checking and correction	LDPC						
Working temperature	0~70°						
Earthquake resistance	80Hz~2000Hz/20G						
Shockproof ability	1500G/0.5MS						
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG						
Characteristic	Support LDPC error correction engine / Support ATA-8 standard Support SATA I/II/III interface / Support hot swap Support power management / Support S.M.A.R.T function Dynamic wear balance function / Support TCG- OPAL2.0						

M.2 2280/2242 SATA SSD



M.2 2280/2242 SATA SSD

M.2 formerly known as NGFF interface, it is a new generation intertacestandard tailored for ultrabook, which is mainly used to Replace msatainterface, with small size Performance mainstream and other characteristicsAnd M.2 has rich scalability, which can improve SSD capacity.

Product Specifications

Product model	C600 2242				C600 2280		
Dimensions	42mm*22mm*3.5mm				80mm*22mm*3.5mm		
Interface type	M.2 NGFF						
Transfer rate	SATAIII 6Gbps						
Capacity	128GB	256GB	1TB	128GB-256GB	512GB-1TB	2TB	
NAND	3D TLC / QLC						
Continuous read speed MB/s	≥450	≥450	≥480	450-500	450-500	500-550	
Continuous write speed MB/s	≥350	≥400	≥400	360-450	450-500	500-520	
Working voltage	DC 3.3V±5%						
Operating power consumption	2.35-2.65W						
Data storage	It can be stored for more than 10 years at 25°C						
Error checking and correction	LDPC						
Operating temperature	0~70°						
Seismic resistance	80Hz~2000Hz/20G						
Shock resistance	1500G/0.5MS						
Function	Power Management/S.M.A.R.T./HMB/NCO/WEAR-LEVEUNG						
Features	Support LDPC error correction engine / Support ATA-8 standard Support SATA I/II/III interface / Support hot swap Support power management / Support S.M.A.R.T function Dynamic wear balance function / Support TCG·OPAL2.0						

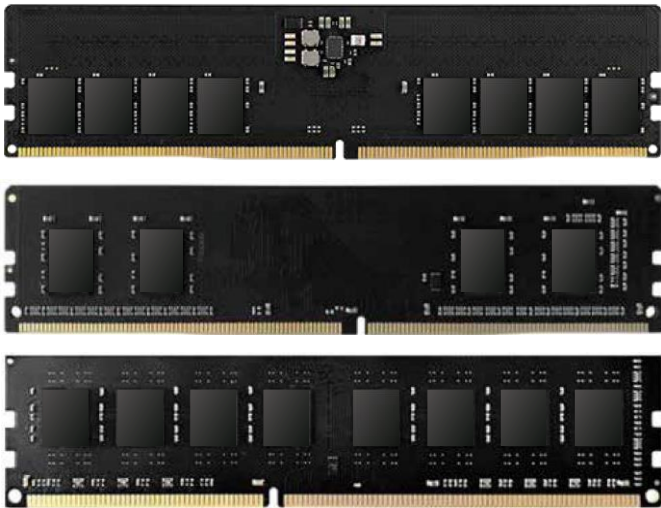
OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

Application



Desktop memory DDR5/DDR4/DDR3



Desktop memory DDR5/DDR4/DDR3

Memory is an important part of computer, also known as memory and main memory.It is used to temporarily store the operations in CPU Calculate data, as well as data exchanged with external memory such as hard disk. It is a bridge between external memory and CPU, which is used in computers All programs run in memory, and the strength of memory performance affects the overall performance of the computer.

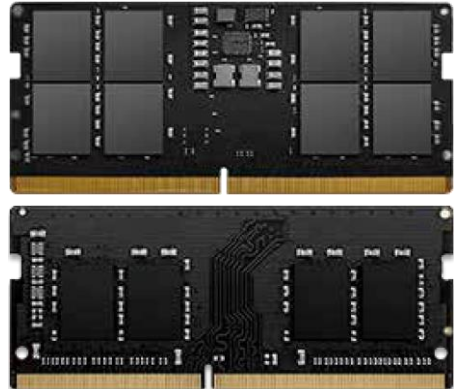
OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

Product Specifications

Product model	C300 PC DDR3	C300 PC DDR4	C300 PC DDR5
Overall dimension	133.3mm*30mm	133.3mm*31.25mm	133.3mm*31.25mm
Frequency range	1333MHz/1600MHz	2400MHz/2666MHz/3000MHz/3200MHz	4800MHz/5200MHz/5600MHz/6000MHz 6400MHz/6800MHz/7200MHz/7600MHz/8000MHz
Capacity	4G/8G	4G/8G/16G/32G	8G/16G/32G/64G
Chip brand	Samsung/SK Hynix/Micron, etc		
Number of chips	4/8/16		
Working temperature	0°C~+85°C		
Working humidity	Relative humidity: 10% -90%		
Storage temperature	0°C~+80°C		
Storage humidity	Relative humidity: 5% -95%		
Working voltage	1.35V/1.5V	1.2V/1.35V	1.1V~1.45V
Working storage air pressure	69-105KPa		
Number of pins	240 pin	288pin	288pin
Impedance	Single-ended 50/55 Ohm±10%	57 Ohm±15%	Differential 83/93 Ohm±15%
Number of PCB layers	8-layers		
Characteristic	Memory is the main part of a computer. It is a program that is usually used compared with external memory, Such as windows operating ystem, typing software, game software, etc., are usually installed on the hard disk And other external memory, you must call them into memory to run, in order to really use their functions.		

Notebook memory DDR5/DDR4/DDR3



Notebook memory DDR5/DDR4/DDR3

Memory is an important part of computer, also known as memory and main memory, It is used to temporarily store the operations in CPU. Calculate data, as well as data exchanged with external memory such as hard disk. It is a bridge between external memory and CPU, which is used in computers. All programs run in memory, and the strength of memory performance affects the overall performance of the computer.

OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

Product Specifications

Product model	C300 NB DDR3	C300 NB DDR4	C300 NB DDR5
Overall dimension	68mm*30mm	69.6mm*30mm	69.6mm*30mm
Frequency range	1333MHz/1600MHz	2400MHz/2666MHz/3000MHz/3200MHz	4800MHz/5200MHz/5600MHz/6000MHz
Capacity	4G/8G	4G/8G/16G/32G	8G/16G/32G
Chip brand	Samsung/SK Hynix/Micron, etc		
Number of chips	4/8/16		
Working temperature	0°C~+85°C		
Working humidity	Relative humidity: 10% -90%		
Storage temperature	0°C~+80°C		
Storage humidity	Relative humidity: 5% -95%		
working voltage	1.35V	1.2V	1.1V
Working storage air pressure	69-105KPa		
Number of pins	204 pin	260pin	260pin
Impedance	Single-ended 50/55 Ohm10%	57 Ohm±15%	Differential 83/93 Ohm±15%
Number of PCB layers	8-layers		
Characteristic	Memory is the main part of a computer. It is a program that is usually used compared with external memory, Such as windows operating system, typing software, game software, etc., are usually installed on the hard disk. And other external memory, you must call them into memory to run, in order to really use their functions.		

Enterprise NVMe SSD (U.2) Solid State Drive



Enterprise NVMe SSD (U.2) Solid State Drive

Usina the advanced 12nm FinFET*4 CMO*5 manufacturing proce itis an industry-eading PCIe Gen4x4, NVMe14 8 NAND CH x 8 CE7 SSD masterchip,which can greatly reduce the data error rate and improve the ability of data persistence. At the same time, it supports advanced functions sucias multi-data encryption and protection mechanism, overtemperature frequency reduction protection, multi-level intelligent power managementand smart cache. Its excellent read and write performance and excellent stability, reliability, and durability make it ideal for storage media.

Product Specifications

Category	NVMe SSD (U.2)	
Dimensions	69.85mm x 100.45mm x 15mm	
Master	InnoGrit Rainier IG5636FAA	
NAND type	YMTC eTLC NAND Flash Array	
Total NAND capacity	1.6TB/1.92TB/3.2TB/3.84TB/7.68TB	
DDR type	Micron DDR4 Array	
Total DDR capacity	5GB/10GB	
Hardware interface	U.2 interface, compliant with SFF-8639 standard	
Host interface	PCIe Gen4 x4, NVMe 1.4	
Operating temperature	Commercial Grade (0 ° C~ + 70 ° C)	
Operating System	Windows 10 and above / Linux / UOS 2.0, won the bid / Galaxy Kirin and other domestic operating systems	
Customizable data security solutions	National Secret Standard: SM2/3/4 Advanced Encryption Standard: AES-128/256 Secure Hashing Algorithm: SHA3-256	

OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

Application

- 

Data Center
- 

Cloud services
- 

IOT
- 

AI Intelligence

Portable SSD



Portable SSD

U disk is a kind of flash memory, also known as flash disk. It eliminates the need for a physical drive, plug-and-play, and has much more storage capacity than floppy disks, making it extremely portable. U disk integrates disk storage technology, flash memory technology and universal serial bus technology.

OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

product features



Reading writing is stable



Metal shell durable



Waterproof and dustproof



Plug and Play



Strong compatibility

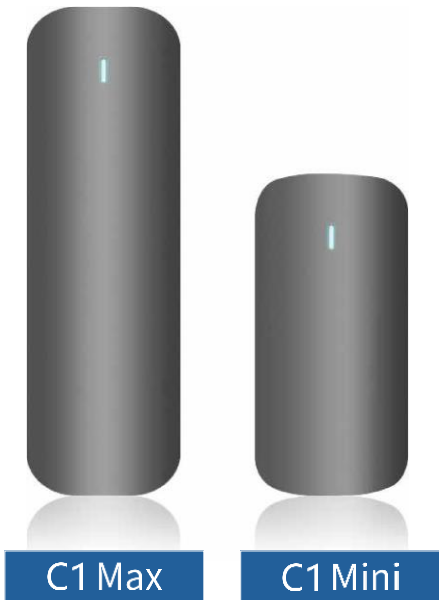


Integrated packaging

Product Specifications

Specifications	USB 3.1 Gen2
Size	30*80*8mm
Interface Type	Type-C
Length	about 30cm
Interface agreement	USB 3.1 Gen 2
Material	Aluminium alloy
working temperature	0~70°C
Warranty	Three-year warranty after purchase

C1 Portable Solid state Drive



C1 Portable Solid State Drive

Type-c to Type-c data cable/USB to Type-c data cable, get rid of the traditionalmechanical hard disk read and write mode, and PSSD greatly improves the read andwrite speed. Large files and high-definition movies can be easily transferred;Compatible with PC.Mac.Android devices, game consoles and other devices.

OEM/ODM customized service

Provide customization: package, model, shell, label, BOM

product features

-  High-speed andstable transmission
-  Easy to carry
-  Safe and reliable
-  Plug and Play
-  ultra-large capacity
-  Strong compatibility

Product Specifications

Product name	C1 SSD
Product material	Aluminum alloy+ABS plastic
Product color	Silver/Grey
Product size	Max (105mm*33mm*9mm)
	Mini (69mm*33mm*9mm)
D1Max read and write speed	Read 1000MB/s, write 950MB/s (512GB)
D1Mini read and write speed	Read 460MB/s, write 450MB/s (256GB)
joggle	Type-C
volume	128GB/256GB/512GB/1TB/2TB/4TB

RGB Memories set



RGB Memories set

Made of high-quality aluminum alloy material, it can increase the heat dissipation efficiency and match with Taiwan's customized 8-layer PCB board to effectively improve the computer efficiency.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and stable transmission



Good compatibility



Broken diamond luminous effect



Convenient installation



Efficient heat dissipation



Stable and durable

Product Specifications

Specifications	Dancer C50 DDR5/DDR4
Size	133.3*52*8mm
volume	8GB/16GB/32G
frequency	2666/3200/3600/5600/6000MHZ
Pin Type	30 micro-inch puregold plating
material	aluminum alloy
working voltage	1.1/1.2V
working temperature	0~70°C
Warranty	Three-year warranty after purchase

RGB memory



RGB memory

Made of high-quality aluminum alloy material, it can increase the heat dissipation efficiency and match with Taiwan's customized 8-layer PCB board to effectively improve the computer efficiency.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and stable transmission



Good compatibility



Broken diamond luminous effect



Convenient installation



Efficient heat dissipation



Stable and durable

Product Specifications

Specifications	C300 PLUS DDR5/DDR4
Interface	288pin U-DIMM
Capacity	8GB/16GB/32GB
Frequency	2666/3200/3600/5600/6000MHZ
Peratin Voltage	1.1V/1.2V
Service temperature	0~70°C

RGB Memories set



RGB Memories set

Made of high-quality aluminum alloy material, it can increase the heat dissipation efficiency and match with Taiwan's customized 8-layer PCB board to effectively improve the computer efficiency.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and stable transmission



Good compatibility



Broken diamond luminous effect



Convenient installation



Efficient heat dissipation

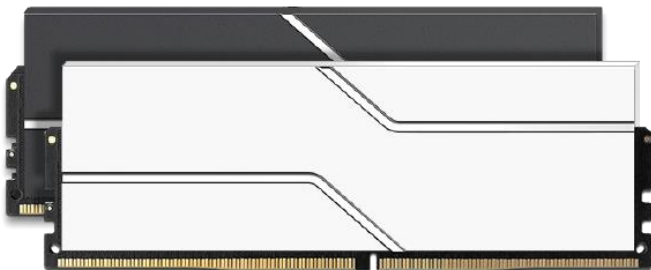


Stable and durable

Product Specifications

Specifications	C800 DDR5/DDR4
Size	133.3*52*8mm
volume	8GB/16GB/32G
frequency	2666/3200/3600/5600/6000MHZ
Pin Type	30 micro-inch puregold plating
material	aluminum alloy
working voltage	1.1/1.2V
working temperature	0~70°C
Warranty	Three-year warranty after purchase

Vest memory



Vest memory

The equipment of the vest strip is mainly to expand the heat dissipation area and increase the heat dissipation function to ensure that there will be no lag in the high temperature environment. Vest strips have better overclocking capabilities than ordinary memory sticks.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and
stable transmission



Good
compatibility



Convenient
installation



Efficient heat
dissipation

Product Specifications

Specifications	C860 PLUS DDR5/DDR4
volume	8GB/16GB/32G
frequency	2666/3200/4800/5200/5600/6000/6400/6800/7200/7600/8000MHz
Pin Type	30 micro-inch puregold plating
Quantity	2PCS
working voltage	1.1/1.2V
working temperature	0~70°C
Warranty	Three-year warranty after purchase

Vest memory



Vest memory

The equipment of the vest strip is mainly to expand the heat dissipation area and increase the heat dissipation function to ensure that there will be no lag in the high temperature environment. Vest strips have better overclocking capabilities than ordinary memory sticks.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and
stable transmission



Good
compatibility



Convenient
installation



Efficient heat
dissipation

Product Specifications

Specifications	C700 DDR5/DDR4
Interface	288pin U-DIMM
Capacity	8GB/16GB/32GB
Frequency	2666/3200/4800/5200/5600/6000/ 6400/6800/7200/7600/8000MHz
Peratin Voltage	1.1V~1.45V
Service temperature	0~70°C



Vest memory



Vest memory

The equipment of the vest strip is mainly to expand the heat dissipation area and increase the heat dissipation function to ensure that there will be no lag in the high temperature environment. Vest strips have better overclocking capabilities than ordinary memory sticks.

OEM/ODM customized service

Provide customization: package, model, shell, label

product features



High-speed and
stable transmission



Good
compatibility



Convenient
installation



Efficient heat
dissipation

Product Specifications

Specifications	C680 DDR5/DDR4
Interface	288pin U-DIMM
Capacity	8GB/16G/32GB
Frequency	2666/3200/4800/5200/5600/6000/ 6400/6800/7200/7600/8000MHz
Peratin Voltage	1.1V~1.45V
Service temperature	0~70°C



Cooling vest



Cooling vest

Made of high-quality aluminum alloy material, it increases heat dissipation efficiency and is paired with a PCB board to effectively improve computer performance.

OEM/ODM customization service:

Provide customization: package, model, shell, label

product features



High-speed and stable transmission



Good compatibility



Convenient installation



Efficient heat dissipation

Product Specifications

Specifications	Cooling vest
Interface	M.2 PCIe Gen4x4
Capacity	512GB-4TB
Performance Read(max.)	Up to 7300MB/s
Performance Write(max.)	Up to 6500MB/s
Service temperature	0~70°C
Warranty	Three-year warranty after purchase

Fingerprint solid state U disk



Fingerprint solid state U

Provide fingerprint protection for USB flash drives and use its "confidential file" function to encrypt files and folders in the local computer. It is extremely safe and confidential, safe to use, and easy to carry!

OEM/ODM customization service:

Provide customization: package, model, shell, label

product features



High-speed and stable transmission



High capacity



Compact and convenient



Security and confidentiality

Product Specifications

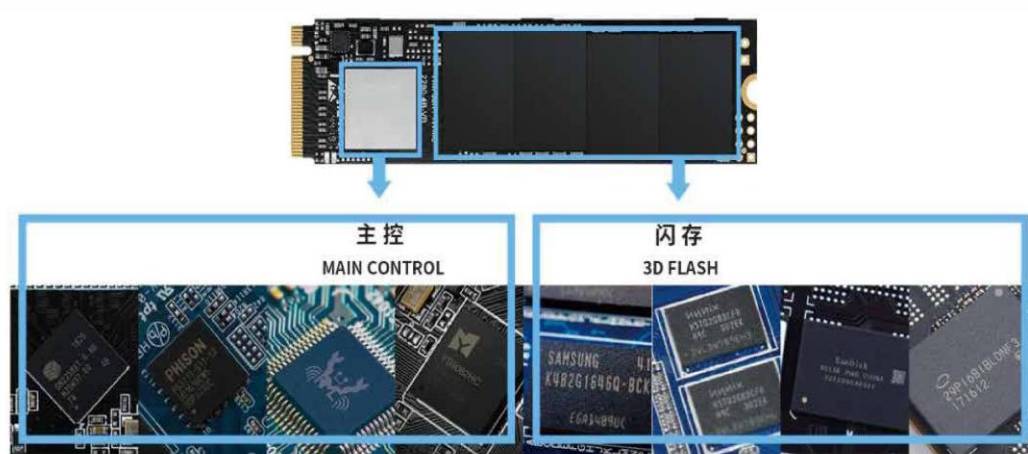
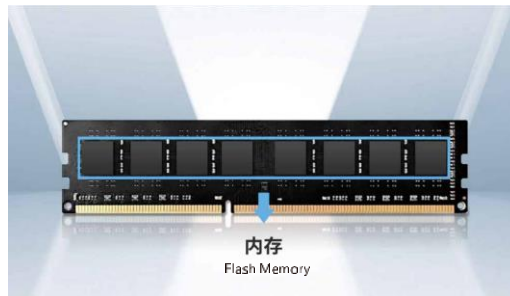
Specifications	Fingerprint solid state U disk-USB 3.2
Shell Material	Aluminum alloy
Capacity	512GB-4TB
Interface type	USB3.2 Gen2+Type-C
Chip	3D Flash
Service temperature	0~70°C
Warranty	Three-year warranty after purchase

SSD OEM ODM product

Among SSD products, Taiwan SMI is adopted Group pH Ruiyu Realtek and Deyi micro's master chip; In order to ensure higher quality. We use first-line original Samsung SKhynix. Micon. Intel products to ensure product stability.

DRAM OEM ODM product line

In order to achieve more stable operation, we use Samsung in desktop and notebook memory. The original flash memory of Micron first line. Continuously ensure the output of higher quality products.



ENTERPRISE VISION



Company Vision

Chuangshi Feida synchronizes with global semiconductor technology



Company Philosophy

Integrity, professionalism, innovation, transcendence



Quality Policy

International Quality Standards, Advanced and Reliable Testing, Efficient and Timely Service

Good storage Chuangshi Feida

Rigorous product production testing process Lower product rework More peace of mind!



AFTER-SALES AND R&D



Dedicated R&D spirit

Chuangshi Feida has the spirit of insisting on innovative research and development and strictly adheres to product quality control. It has introduced cutting-edge technical teams, laboratories and manufacturing equipment, and has strong vertical integration capabilities in product design, raw material acquisition, production process, and quality inspection. Only then can be field-leader and introduces latest memory modules.

After-Services

Chuangshi Feida adheres to the business philosophy of integrity, innovation, professionalism, efficiency, focus and service, and provides comprehensive warranty services for all series of Chuangshi Feida products to strengthen customer service. The speed of repair and replacement is better than other brands, and the fastest. The speed of the product is delivered to every customer in the world, and it has won the support and praise of the industry and consumers.



QUALITY MANAGEMENT



Material selection

1. Professional master control chip solution
2. High quality Flash particles
3. Professional industry-level electronic parts

Product customization

1. Customizable BOM processing
2. Corresponding industry market PCBA design
3. Software customization service

Test verification

1. High and low temperature RDT/BIT test
2. High and low temperature DATA RETENTION test
3. Industrial control platform equipment compatibility test verification.

Production technology

1. Professional SMT
2. High temperature reflow soldering
3. AOI
4. Vibration test

Quality inspection

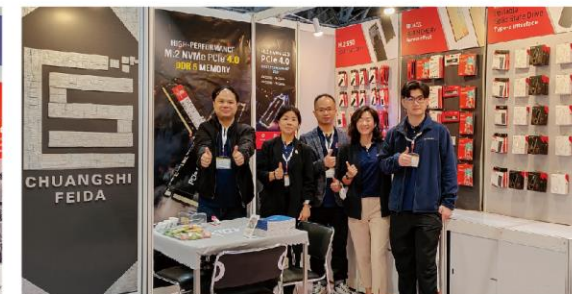
1. Chuangshi Feida Semiconductor Professional Inspection Specifications
2. Strictly control each link of QA/QC/FQC/OQC

Professional team

1. Professional team
2. Regular product professional training and assessment within the company



STAFF STYLE



Enterprise Certificate



Company patent

After 10 years of professional accumulation, our company has mastered advanced design and manufacturing technology, Obtained a number of utility model patents.



CERTIFICATES

After 10 years of professional accumulation, our company has mastered advanced design and manufacturing technology, Gained industry recognition.



GLOBAL SALES

Chuangshi Feida storage products are sold all over the world with high reputation.

Asia

Japan, South Korea, Palestine, Vietnam
India, Thailand, Pakistan, Malaysia, Iran etc.

Europe

Germany, France, Austria, United Kingdom, Netherlands, Spain, Poland, Sweden, Denmark, Greece, Portugal etc.

America

American, Brazil, Colombia, Chile, Peru etc

Africa

South Africa, Egypt and others.



DRAM / SSD / PSSD / U disk One-stop storage solution provider